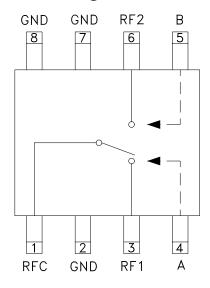


### **Typical Applications**

The HMC239S8 is ideal for:

- MMDS & WirelessLAN
- Basestation Infrastructure
- Portable Wireless

#### Functional Diagram



#### **Features**

Low Insertion Loss: 0.4 dB

High Isolation: 35 dB

Fast Switching Speed: 2ns High Input IP3: +50 dBm

### General Description

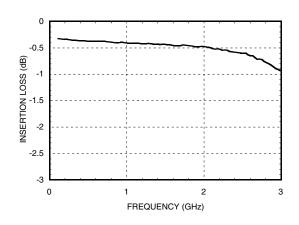
The HMC239S8 is a low-cost GaAs MMIC SPDT switch in an 8-lead SOIC package. The switch can control signals from DC to 2.5 GHz. It is especially suited for low or medium power applications which require extremely fast switching with minimal insertion loss. The two control voltages require a minimal amount of DC current which is optimal for battery powered radio systems. RF1 and RF2 are reflective shorts when "Off".

## Electrical Specifications, $T_A = +25^{\circ}$ C, Vctl = 0/-5V, 50 Ohm System

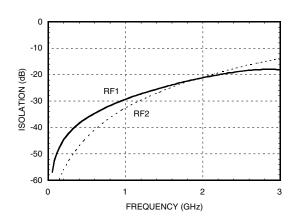
Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 0.1 GHz DC - 0.5 GHz DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz		0.4 0.4 0.5 0.6 0.7	0.6 0.6 0.7 0.8 1.0	dB dB dB dB dB
Isolation	DC - 0.5 GHz DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz	33 26 18 14	36 29 21 17		dB dB dB dB
Return Loss	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz	18 17 15	21 21 20		dB dB dB
Input Power for 1dB Compression 0/-5V Control	0.5 - 1.0 GHz 0.5 - 2.5 GHz	25 23	29 27		dBm dBm
Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone) 0/-5V Control	0.5 - 1.0 GHz 0.5 - 2.5 GHz	45 44	50 49		dBm dBm
Switching Characteristics	DC - 2.5 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)			2 10		ns ns



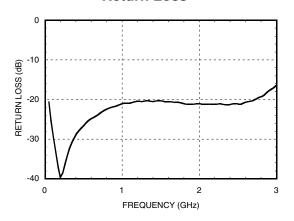
#### Insertion Loss



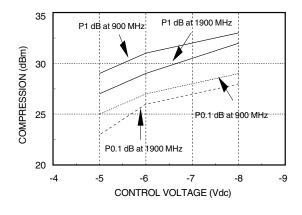
#### Isolation



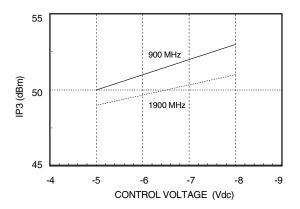
#### Return Loss



Input 0.1 and 1.0 dB Compression vs. Control Voltage



Input Third Order Distortion vs. Control Voltage





#### Truth Table

\*Control Input Voltage Tolerances are ± 0.2 Vdc.

Contro	I Input*	Control Current		Signal Path State	
A (Vdc)	B (Vdc)	la (uA)	lb (uA)	RF to RF1	RF to RF2
-5	0	-25	10	ON	OFF
0	-5	10	-25	OFF	ON
-6	0	-75	30	ON	OFF
0	-6	30	-75	OFF	ON
-7	0	-130	60	ON	OFF
0	-7	60	-130	OFF	ОМ
-8	0	-190	80	ON	OFF
0	-8	80	-190	OFF	ON

## Compression vs. Bias Voltage

	Carrier at 900 MHz		Carrier at 1900 MHz		
Control Input	Input Power for 0.1 dB Compression	Input Power for 1.0 dB Compression	Input Power for 0.1 dB Compression	Input Power for 1.0 dB Compression	
(Vdc)	(dBm)	(dBm)	(dBm)	(dBm)	
-5	25	29	23	27	
-6	27	31	26	29	
-8	29	33	28	32	

Caution: Do not operate in 1 dB compression at power levels above +30 dBm and do not "hot switch" power levels greater than +20 dBm (Vctl= -5 Vdc).

## Distortion vs. Bias Voltage

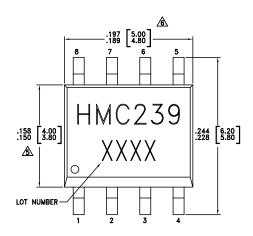
Control Input	Third Order Intercept (dBm) +7 dBm Each Tone	
(Vdc)	900 MHz	1900 MHz
-5	50	49
-8	53	51

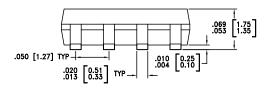


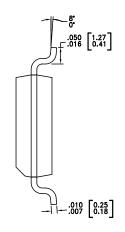
## Absolute Maximum Ratings

Max. Input Power (VCTL = 0/-8V)	0.05 GHz 0.5 - 2 GHz		
Control Voltage Range (A & B)		+2 to -12 Vdc	
Storage Temperature		-65 to +150 °C	
Operating Temperature		-40 to +85 °C	

## **Outline Drawing**







#### NOTES:

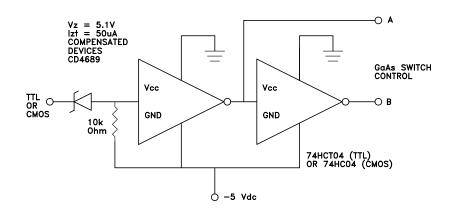
- PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEADFRAME MATERIAL: COPPER ALLOY
- 3. LEADFRAME PLATING: Sn/Pb SOLDER
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].

DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.

7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.



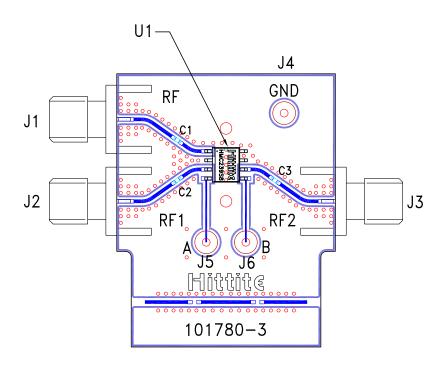
# **Typical Application Circuit**



Simple driver using inexpensive standard logic ICs provides fast switching using minimum DC current.



#### **Evaluation Circuit Board**



#### List of Material

Item	Description	
J1 - J3	PC Mount SMA RF Connector	
J4 - J6	DC Pin	
C1 - C3	330 pF capacitor, 0402 Pkg.	
U1 HMC239S8 SPDT Switch		
PCB*	101780 Evaluation PCB	
* Circuit Board Material: Rogers 4350		

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.